

# U.S. UTILITY Patent Application

PRO.I.P.E. SCANNED <i>AK2</i> O.A. <i>6</i>	PATENT DATE
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APPLICATION NO. 09/903114	CONT/PRIOR D	CLASS 427	SUBCLASS 58	ART UNIT 1762	EXAMINER <i>Talbot</i>
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TITLE  
 Thermal processing system and methods for forming low-k dielectric films suitable for incorporation into microelectronic devices

PTO-2040  
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ISSUING CLASSIFICATION							
ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>  <input type="checkbox"/> The term of this patent subsequent to (date) has been disclaimed.  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No.	<b>DRAWINGS</b> Sheets Drwg. Figs. Drwg. Print Fig.		<b>CLAIMS ALLOWED</b> Total Claims Print Claim for O.G.	
	(Assistant Examiner) (Date)		<b>NOTICE OF ALLOWANCE MAILED</b>	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No.	(Primary Examiner) (Date)		<b>ISSUE FEE</b> Amount Due Date Paid	
	(Legal Instruments Examiner) (Date)		<b>ISSUE BATCH NUMBER</b>	

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